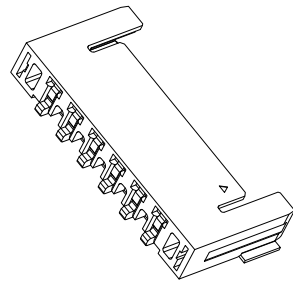


REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			NEW RELEASE	07/11'25	David

### 3D VIEW



#### ORDERING INFORMATION

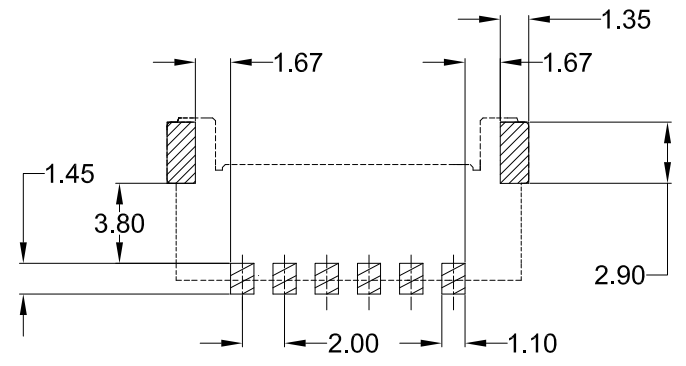
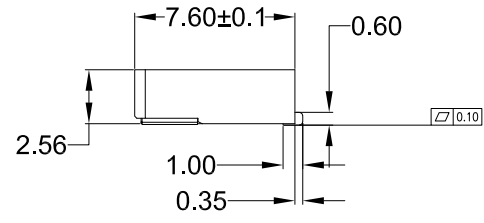
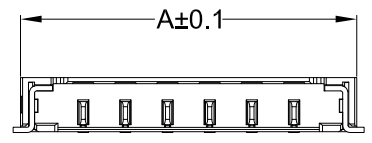
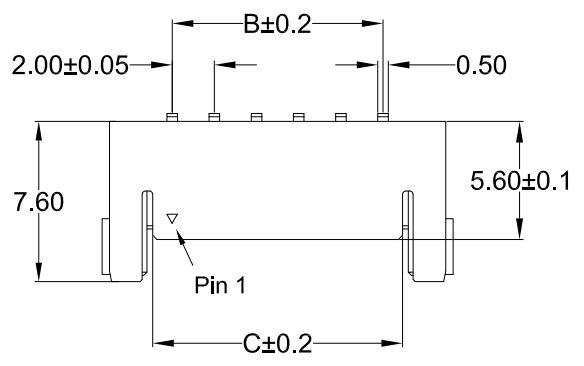
**WB200H256 - XX (XX R)**

① ② ③ ④

- ① **PRODUCT SERIES:**  
 Wire To Board Connector  
 Pitch 2.0mm /Height 2.56mm  
 Right Angle-Single Row
- ② **NUMBER OF CONTACTS:**  
 SEE DIM. TABLE

**CUSTOMER DRAWING**  
 RoHS Compliant

- ③ **PLATING :**  
 01: G/F plated.
- ④ **PACKING :**  
 R: Reel.

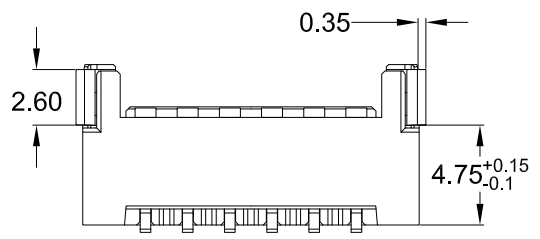


RECOMMEND PCB LAYOUT  
 GENERAL TOLERANCE: ±0.05

- NOTES:**
- Material:  
 1. Contact: Copper Alloy.  
 2. Insulator: High Temp, UL94V-0.  
 3. Fit: Copper Alloy.
  - Plating:  
 1. Contact: Gold over Nickel under-plated overall.  
 2. Fit: Tin over Nickel under-plated overall.
  - Specifications:  
 1. Voltage rating: 250V AC/DC  
 2. Current rating: 6.5A AC/DC  
 3. Withstanding voltage: 800V AC/minute  
 4. Temperature range: -40°C+85°C  
 5. Insulation resistance: ≥1000MΩ.  
 6. Contact resistance: ≤20mΩ.

#### DIMENSION TABLE:

Pin No	Dimensions(mm)		
	Dim A	Dim B	Dim C
02	7.95	2.00	3.85
03	9.95	4.00	5.85
04	11.95	6.00	7.85
05	13.95	8.00	9.85
06	15.95	10.00	11.85
07	17.95	12.00	13.85
08	19.95	14.00	15.85
09	21.95	16.00	17.85
10	23.95	18.00	19.85
11	25.95	20.00	21.85
12	27.95	22.00	23.85
13	29.95	24.00	25.85
14	31.95	26.00	27.85
15	33.95	28.00	29.85
16	35.95	30.00	31.85



DIM	TOL	DIM	TOL
X.X	±0.20	X.X'	±3.0'
X.XX	±0.10	X.XX'	±2.0'
X.XXX	±0.05	X.XXX'	±1.0'

<b>SUNFUN</b>		<b>SUNFUN TECHNOLOGY LTD</b>			
DRAW NO.	WB200H256(A0)	DATE	07/11'25	MATERIAL:	SEE NOTES
DESIGN:	David	DATE	07/11'25	FINISH:	SEE NOTES
CHECK:	David	DATE	07/11'25	FILE:	WB200H256(A0)
REVIEW:	Frank	DATE	07/11'25	P/N:	WB200H256-XX(XXR)
APPROVED	Frank	DATE	07/11'25	REV. A0	SCALE
DRAW NAME:		Wire To Board CONN: Pitch 2.0mm /Height 2.56mm Right Angle-Single Row			
MODEL:		P2.0 WTB CONN			
UNIT:	mm	SHEET:	1/1		